

Board Level Cooling – Extruded Channel



BOARD LEVEL COOLING - Extruded Channel

Extruded Channel is a channel board level heat sink designed to cool TO-220 and TO-220-single gauge devices. Representative image only.

ORDERING INFORMATION

Part Number	Device Type
ML26AAG	TO-220, TO-220-single gauge



HEAT SINK DETAILS

Property	Details
Material	Aluminum
Finish	Black Anodize
Device Attachment Options	Requires Mounting Kit
Thermal Interface Material	-

Property	Details
Heat Sink Width (mm)	15.0
Heat Sink Length (mm)	20.0
Heat Sink Height (mm)	25.0
Heat Sink Mounting Direction	Vertical

MECHANICAL & PERFORMANCE

Drawing dimensions are shown in mm, (in)

